

# Dual-Synchronous, Step-Down Controller with Out-of-Audio™ Operation and 100-mA LDOs for Notebook System Power

Check for Samples: TPS51123

#### **FEATURES**

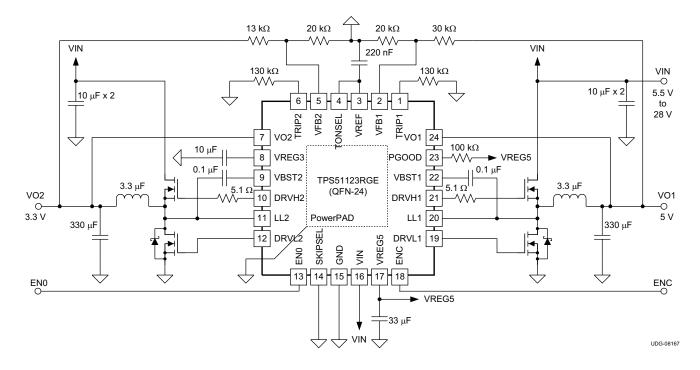
- Wide-Input Voltage Range: 5.5 V to 28 V
- Output Voltage Range: 2 V to 5.5 V
- Built-in 100-mA 5-V/3.3-V LDO with Switches
- Built-in 1% 2-V Reference Output
- With/Without Out-of-Audio<sup>™</sup> Mode Selectable Light-Load and PWM only Operation
- Internal 1.6-ms Voltage Servo Softstart
- Adaptive On-Time Control Architecture with Four Selectable Frequency Setting
- 4500 ppm/°C R<sub>DS(on)</sub> Current Sensing
- Built-In Output Discharge
- Power Good Output
- Built-in OVP/UVP/OCP
- Thermal Shutdown (Non-latch)
- 24-Pin QFN (RGE) Package

#### **APPLICATIONS**

- Notebook Computers
- I/O Supplies
- System Power Supplies

#### DESCRIPTION

The TPS51123 is a cost effective, dual-synchronous buck controller targeted for notebook system power supply solutions. It provides 5-V and 3.3-V LDOs and requires few external components. The TPS51123 supports high efficiency, fast transient responses and provides a combined power-good signal. Out-of-Audio™ mode light-load operation enables low acoustic noise at much higher efficiency than conventional forced PWM operation. Adaptive ontime D-CAP™ control provides convenient and efficient operation. The part operates with supply input voltages ranging from 5.5 V to 28 V and supports output voltages from 2 V to 5.5 V. The TPS51123 is available in a 24-pin QFN package and is specified from -40°C to 85°C ambient temperature range.



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Out-of-Audio, D-CAP are trademarks of Texas Instruments.



#### ORDERING INFORMATION<sup>(1)</sup>

T <sub>A</sub>	PACKAGE	ORDERABLE DEVICES	PINS	TRANSPORT MEDIA	MINIMUM QUANTITY	ECO PLAN
-40°C to 85°C	Plastic Quad Flat Pack	TPS51123RGET	24	Tana/Daal	250	Green (RoHS and no
-40 'C 10 65 'C	(QFN)	TPS51123RGER	24	Tape/Reel	3000	Sb/Br)

<sup>(1)</sup> For the most current spcifications and package information, see the *Package Option Addendum* located at the end of this data sheet or refer to our web site at http://www.ti.com.

# ABSOLUTE MAXIMUM RATINGS(1)

over operating free-air temperature range (unless otherwise noted)

	DADAMETED	VALU	IE	UNIT
	PARAMETER	MIN	MAX	
	VBST1, VBST2	-0.3	36	
	VIN	-0.3	30	
Input voltage range (1)	LL1, LL2	-2.0	30	V
Input voltage range (1)	LL1, LL2, pulse width < 20 ns	-5.0	30	V
	VBST1, VBST2 (2)		6	
	EN0, ENC, TRIP1, TRIP2, VFB1, VFB2, VO1, VO2, TONSEL, SKIPSEL	-0.3	6	
	DRVH1, DRVH2	-1.0	36	
Output voltage range (1)	DRVH1, DRVH2 (2)	-0.3	6	V
	PGOOD, VREG3, VREG5, VREF, DRVL1, DRVL2		6	
	Human body model QSS 009-105 (JESD22-A114A		2	1.37
Electrostatic discharge	Charged device model QSS 009-147 (JESD22-C101B.01)		1.5	kV
Junction temperature range, T <sub>J</sub>		-40	125	
Storage temperature, T <sub>stg</sub>		-55	150	°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# **DISSIPATION RATINGS**

2-oz. trace and copper pad with solder.

PACKAGE	T <sub>A</sub> < 25°C POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 85°C POWER RATING
24-pin RGE <sup>(1)</sup>	1.85 W	18.5 mW/°C	0.74 W

(1) Enhanced thermal conductance by 3 x 3 thermal vias beneath thermal pad.

<sup>(2)</sup> Voltage values are with respect to the corresponding LLx terminal.



# **RECOMMENDED OPERATING CONDITIONS**

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	MIN	TYP MAX	UNIT
Supply voltage	VIN	5.5	28	
	VBST1, VBST2	-0.1	34	
Input voltage range	VBST1, VBST2 (wrt LLx)	-0.1	5.5	
input voltage range	ENO, ENC, TRIP1, TRIP2, VFB1, VFB2, VO1, VO2, TONSEL, SKIPSEL	-0.1	5.5	
	DRVH1, DRVH2	-0.8	34	V
	DRVH1, DRVH2 (wrt LLx)	-0.1	5.5	
Output voltage range	LL1, LL2	-1.8	28	
	VREF, VREG3, VREG5	-0.1	5.5	
	PGOOD, DRVL1, DRVL2	-0.1	5.5	
T <sub>A</sub>	Operating free-air temperature	-40	85	°C



#### **ELECTRICAL CHARACTERISTICS**

over operating free-air temperature range, VIN = 12 V (unless otherwise noted)

TRIP1 = TRIP2 = 2 V, VFB1 = VFB2 = 2.05 V		PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
VIN supply current   VIN supply current   VO2 = 0 V. EN0-opper, ENC = 5 V.   TRIP1 = TRIP2 = 2.05 V   VFB1 = VFB2 = 2.05 V   VFB1 = 2.05	SUPPLY	CURRENT					
Voice   Voic	I <sub>VIN1</sub>	VIN supply current1	VO2 = 0 V, EN0=open, ENC = 5 V,		0.55	1	mA
VO2 = 3.3 V, ENG—open, ENC = 5 V,   VO2 = 2.0 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO2 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE2 = 2.05 V   VO3 = V, VPE1 + VPE	I <sub>VIN2</sub>	VIN supply current2	VO2 = 3.3 V, EN0=open, ENC = 5 V, TRIP1 = TRIP2 = 2 V, VFB1 = VFB2 = 2.05 V		4	6.5	μΑ
VO2 = 3.3 V, EN0=open, ENC = 5 V,	I <sub>VO1</sub>	VO1 current	VO2 = 3.3 V, EN0=open, ENC = 5 V,		0.8	1.5	mA
Vinistray   Vinistration   Vinistr	I <sub>VO2</sub>	VO2 current $VO2 = 3.3 \text{ V}, EN0 = \text{open}, ENC = 5 \text{ V}$			12	100	
VREF OUTPUT   VREF output voltage   VREF output voltage   VREF output voltage   VREF output voltage   VREGS OUTPUT   VOREGS < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2   VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25   VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25   VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25   VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25   VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 100 mA   1.0   175   250   VO1 = 5 V, I <sub>VREGS</sub> < 100 mA   1.0	I <sub>VINSTBY</sub>	VIN standby current			95	250	μΑ
V <sub>VREF</sub> VREF output voltage         I <sub>VREF</sub> = 0 A −5 μA < I <sub>VREF</sub> < 100 μA         1.98 ± 2.00         2.02 ± 2.03           VREG5 OUTPUT           V <sub>VREG5</sub> VREG5 output voltage         VO1 = 0 V, I <sub>VREG5</sub> < 100 mA, T <sub>A</sub> = 25°C         4.8 ± 5 ± 5.2           V <sub>VREG5</sub> VREG5 output voltage         VO1 = 0 V, I <sub>VREG5</sub> < 50 mA, 5.5 V < VIN < 28 V	I <sub>VINSDN</sub>	VIN shutdown current			10	25	
VREF   VREF output voltage   VREF output voltage   VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C   4.8   5   5.2     VO1 = 0 V, I <sub>VREGS</sub> < 50 mA, 5.5 V < VIN < 28 V   4.75   5   5.25     VREGS output current   VO1 = 0 V, VREGS = 4.5 V   100   175   250     V <sub>THSVSW</sub>   Switch over threshold   Hysteresis   0.15   0.25   0.3     V <sub>SSW</sub>   5 V SW R <sub>ON</sub>   VO1 = 5 V, I <sub>VREGS</sub> = 100 mA   1   3     VREG3 OUTPUT   VREG3 Output voltage   VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C   3.2   3.33   3.46     VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C   3.2   3.33   3.3     V <sub>SSW</sub>   VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C   3.2   3.33   3.3     V <sub>SSW</sub>   V <sub>S</sub>   VREG3 output voltage   VO2 = 0 V, I <sub>VREG3</sub> < 50 mA, 5.5 V < VIN < 28 V   3.13   3.33   3.5     V <sub>S</sub>   VREG3 output current   VO2 = 0 V, VREG3 = 3 V   100   175   250     V <sub>THSVSW</sub>   Switch over threshold   Turns on   3.05   3.15   3.25     V <sub>THSVSW</sub>   Switch over threshold   Turns on   3.05   3.15   3.25     V <sub>S</sub>   V <sub>S</sub>	VREF OU	TPUT					
VREGS OUTPUT  Voreight VREGS output voltage  VREGS output voltage  VREGS output voltage  VREGS output voltage  VREGS output current  VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, T <sub>A</sub> = 25°C  VO1 = 0 V, I <sub>VREGS</sub> < 100 mA, E <sub>C</sub> V V V V V V V V V V V V V V V V V V V	V	V/DEE output voltage	I <sub>VREF</sub> = 0 A	1.98	2.00	2.02	V
V <sub>VREGS</sub> VREG5 output voltage         VO1 = 0 V, I <sub>VREG5</sub> < 100 mA, T <sub>A</sub> = 25°C         4.8         5         5.2           V <sub>VREG5</sub> VREG5 output voltage         VO1 = 0 V, I <sub>VREG5</sub> < 100 mA, 6.5 V < VIN < 28 V	VVREF	VREF output voltage	-5 μA < I <sub>VREF</sub> < 100 μA		2.00	2.03	V
V <sub>VREG5</sub> VREG5 output voltage         VO1 = 0 V, I <sub>VREG5</sub> < 100 mA, 6.5 V < VIN < 28 V         4.75         5         5.25           I <sub>VREG5</sub> VREG5 output current         VO1 = 0 V, I <sub>VREG5</sub> < 50 mA, 5.5 V < VIN < 28 V         4.75         5         5.25           I <sub>VREG5</sub> VREG5 output current         VO1 = 0 V, I <sub>VREG5</sub> < 50 mA, 5.5 V < VIN < 28 V         4.75         5         5.25           V <sub>THSVSW</sub> Switch over threshold         Turns on         4.55         4.7         4.85           Hysteresis         0.15         0.25         0.3           VREG3 OUTPUT           V <sub>VREG3</sub> VREG3 output voltage         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C         3.2         3.33         3.46           V <sub>VREG3</sub> VREG3 output voltage         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V         3.13         3.33         3.5           I <sub>VREG3</sub> VREG3 output current         VO2 = 0 V, VREG3 = 3 V         100         175         250           V <sub>TH3VSW</sub> Switch over threshold         Turns on         3.05         3.15         3.25           I <sub>VREG3</sub> VREG3 output voltage         VO2 = 0 V, VREG3 = 3 V         100         175         250           V <sub>TH3VSW</sub> Switch over threshold         I <sub>V</sub>	VREG5 O	UTPUT					
Section   Sect			VO1 = 0 V, I <sub>VREG5</sub> < 100 mA, T <sub>A</sub> = 25°C	4.8	5	5.2	
V <sub>REG5</sub>   VREG5 output current   VO1 = 0 V, VREG5 = 4.5 V   100   175   250     V <sub>TH5VSW</sub>   Switch over threshold   Turns on   4.55   4.7   4.85     Hysteresis   0.15   0.25   0.3     Hysteresis   0.15   0.25   0.3     VREG3 OUTPUT     VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C   3.2   3.33   3.46     VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V   3.13   3.33   3.5     VO2 = 0 V, I <sub>VREG3</sub> < 50 mA, 5.5 V < VIN < 28 V   3.13   3.33   3.5     VO2 = 0 V, I <sub>VREG3</sub> < 50 mA, 5.5 V < VIN < 28 V   3.13   3.33   3.5     V <sub>REG3</sub>   VREG3 output current   VO2 = 0 V, VREG3 = 3 V   100   175   250     V <sub>TH3VSW</sub>   Switch over threshold   Turns on   3.05   3.15   3.25     Hysteresis   0.1   0.2   0.25     R <sub>3VSW</sub>   3 V SW R <sub>ON</sub>   VO2 = 3.3 V, I <sub>VREG3</sub> = 100 mA   1.5   4     INTERNAL REFERENCE VOLTAGE     V <sub>IREF</sub>   Internal reference voltage   I <sub>VREF</sub> = 0 A, beginning of ON state   1.95   1.98   2.01   2.04     FB voltage, I <sub>VREF</sub> = 0 A, skip mode   1.98   2.01   2.035     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)   2.	$V_{VREG5}$	VREG5 output voltage		4.75	5	5.25	٧
V <sub>TH5VSW</sub> Switch over threshold         Turns on Hysteresis         4.55         4.7         4.85 Hysteresis           R <sub>5VSW</sub> 5 V SW R <sub>ON</sub> VO1 = 5 V, I <sub>VREG5</sub> = 100 mA         1         3           VREG3 OUTPUT         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C         3.2         3.33         3.46           VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V			VO1 = 0 V, I <sub>VREG5</sub> < 50 mA, 5.5 V < VIN < 28 V	4. 75	5	5.25	
V <sub>TH5VSW</sub> Switch over threshold         Hysteresis         0.15         0.25         0.3           R <sub>5VSW</sub> 5 V SW R <sub>ON</sub> VO1 = 5 V, I <sub>VREGS</sub> = 100 mA         1         3           VREG3 OUTPUT         VREG3 output voltage         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C         3.2         3.33         3.46           V <sub>VREG3</sub> VREG3 output voltage         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V	I <sub>VREG5</sub>	VREG5 output current	VO1 = 0 V, VREG5 = 4.5 V	100	175	250	mA
Hysteresis	V	Switch over threshold	Turns on	4.55	4.7	4.85	V
VREG3 OUTPUT           VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C         3.2         3.33         3.46           VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V	VTH5VSW	Switch over threshold	Hysteresis	0.15	0.25	0.3	V
$V_{VREG3}  VREG3 \; \text{output voltage} \qquad \begin{array}{c} VO2 = 0 \; V, \; I_{VREG3} < 100 \; \text{mA}, \; T_{A} = 25^{\circ}\text{C} \\ VO2 = 0 \; V, \; I_{VREG3} < 100 \; \text{mA}, \; 6.5 \; V < VIN < 28 \; V \\ 3.13  3.33  3.5 \\ \hline VO2 = 0 \; V, \; I_{VREG3} < 50 \; \text{mA}, \; 5.5 \; V < VIN < 28 \; V \\ 3.13  3.33  3.5 \\ \hline VO2 = 0 \; V, \; I_{VREG3} < 50 \; \text{mA}, \; 5.5 \; V < VIN < 28 \; V \\ 3.13  3.33  3.5 \\ \hline VO2 = 0 \; V, \; I_{VREG3} < 50 \; \text{mA}, \; 5.5 \; V < VIN < 28 \; V \\ 3.10  175  250 \\ \hline V_{CH3VSW}  Switch \; \text{over threshold} \\ \hline V_{TH3VSW}  Switch \; \text{over threshold} \\ \hline V_{TH3VSW}  Switch \; \text{over threshold} \\ \hline V_{TH3VSW}  SWINCHO \; \text{over threshold} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  SWINCHO \; \text{over threshold} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  SWINCHO \; \text{over threshold} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  SWINCHO \; \text{over threshold} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  SWINCHO \; VO2 = 3.3 \; V, \; I_{VREG3} = 100 \; \text{mA} \\ \hline V_{VSW}  $	R <sub>5VSW</sub>	5 V SW R <sub>ON</sub>	VO1 = 5 V, I <sub>VREG5</sub> = 100 mA		1	3	Ω
VVREG3         VREG3 output voltage         VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V         3.13         3.33         3.5           I <sub>VREG3</sub> VREG3 output current         VO2 = 0 V, VREG3 = 3 V         100         175         250           V <sub>TH3VSW</sub> Switch over threshold         Turns on         3.05         3.15         3.25           Hysteresis         0.1         0.2         0.25           R <sub>3VSW</sub> 3 V SW R <sub>ON</sub> VO2 = 3.3 V, I <sub>VREG3</sub> = 100 mA         1.5         4           INTERNAL REFERENCE VOLTAGE         I <sub>VREF</sub> = 0 A, beginning of ON state         1.95         1.98         2.01           FB voltage, I <sub>VREF</sub> = 0 A, skip mode         1.98         2.01         2.04           FB voltage, I <sub>VREF</sub> = 0 A, skip mode         1.9849         2.01         2.0351           FB voltage, I <sub>VREF</sub> = 0 A, OOA mode (1)         2.00         2.035         2.07           FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)         2.00         2.00         2.00           I <sub>VFB</sub> VFB input current         VFBx = 2.0 V, T <sub>A</sub> = 25°C         -20         20           OUTPUT VOLTAGE, V <sub>OUT</sub> DISCHARGE         This and the contract of the contr	VREG3 O	UTPUT					
VO2 = 0 V, I <sub>VREG3</sub> < 50 mA, 5.5 V < VIN < 28 V   3.13   3.33   3.5     I <sub>VREG3</sub>   VREG3 output current   VO2 = 0 V, VREG3 = 3 V   100   175   250     V <sub>TH3VSW</sub>   Switch over threshold   Turns on   3.05   3.15   3.25     Hysteresis   0.1   0.2   0.25     Hysteresis   0.1   0.2   0.25     Hysteresis   0.1   0.2   0.25     Hysteresis   0.1   0.2   0.25     Hysteresis   VO2 = 3.3 V, I <sub>VREG3</sub> = 100 mA   1.5   4     INTERNAL REFERENCE VOLTAGE     V <sub>IREF</sub>   Internal reference voltage   I <sub>VREF</sub> = 0 A, beginning of ON state   1.95   1.98   2.01     FB voltage, I <sub>VREF</sub> = 0 A, skip mode   1.98   2.01   2.04     FB voltage, I <sub>VREF</sub> = 0 A, ooA mode   (1)   2.00   2.035   2.07     FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode   (1)   2.00   2.035     I <sub>VFB</sub>   VFB input current   VFBx = 2.0 V, T <sub>A</sub> = 25°C   -20   20     OUTPUT VOLTAGE, V <sub>OUT</sub> DISCHARGE   Title of the last the state of the state			VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, T <sub>A</sub> = 25°C	3.2	3.33	3.46	
Value   Valu	$V_{VREG3}$	VREG3 output voltage	VO2 = 0 V, I <sub>VREG3</sub> < 100 mA, 6.5 V < VIN < 28 V	3.13	3.33	3.5	V
V <sub>TH3VSW</sub> Switch over threshold         Turns on Hysteresis         3.05         3.15         3.25           R <sub>3VSW</sub> 3 V SW R <sub>ON</sub> VO2 = 3.3 V, I <sub>VREG3</sub> = 100 mA         1.5         4           INTERNAL REFERENCE VOLTAGE           V <sub>IREF</sub> Internal reference voltage         I <sub>VREF</sub> = 0 A, beginning of ON state         1.95         1.98         2.01           FB voltage, I <sub>VREF</sub> = 0 A, skip mode         1.98         2.01         2.04           FB voltage, I <sub>VREF</sub> = 0 A, skip mode, T <sub>A</sub> = 25°C         1.9849         2.01         2.0351           FB voltage, I <sub>VREF</sub> = 0 A, OOA mode (1)         2.00         2.035         2.07           FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode (1)         2.00         2.035         2.00           I <sub>VFB</sub> VFB input current         VFBx = 2.0 V, T <sub>A</sub> = 25°C         -20         20           OUTPUT VOLTAGE, V <sub>OUT</sub> DISCHARGE			VO2 = 0 V, I <sub>VREG3</sub> < 50 mA, 5.5 V < VIN < 28 V	3.13	3.33	3.5	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	I <sub>VREG3</sub>	VREG3 output current	VO2 = 0 V, VREG3 = 3 V	100	175	250	mA
	\/	Curitab avar threehold	Turns on	3.05	3.15	3.25	V
INTERNAL REFERENCE VOLTAGE $V_{IREF}  \text{Internal reference voltage}  I_{VREF} = 0 \text{ A, beginning of ON state} \qquad 1.95 \qquad 1.98 \qquad 2.01$ $FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode} \qquad 1.98 \qquad 2.01 \qquad 2.04$ $FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode}, T_A = 25^{\circ}\text{C} \qquad 1.9849 \qquad 2.01 \qquad 2.0351$ $FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} \qquad 2.00 \qquad 2.035 \qquad 2.07$ $FB \text{ voltage, } I_{VREF} = 0 \text{ A, continuous conduction} \qquad 2.00$ $I_{VFB}  \text{VFB input current} \qquad \text{VFBx} = 2.0 \text{ V, } T_A = 25^{\circ}\text{C} \qquad -20 \qquad 20$ $OUTPUT \text{ VOLTAGE, } V_{OUT} \text{ DISCHARGE}$	VTH3VSW	Switch over threshold	Hysteresis	0.1	0.2	0.25	V
$V_{IREF}  \text{Internal reference voltage}  \begin{aligned} & I_{VREF} = 0 \text{ A, beginning of ON state} & 1.95 & 1.98 & 2.01 \\ & FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode} & 1.98 & 2.01 & 2.04 \\ & FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode, } T_{A} = 25^{\circ}\text{C} & 1.9849 & 2.01 & 2.0351 \\ & FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & (1) & 2.00 & 2.035 & 2.07 \\ & FB \text{ voltage, } I_{VREF} = 0 \text{ A, continuous conduction} & 2.00 $	R <sub>3VSW</sub>	3 V SW R <sub>ON</sub>	$VO2 = 3.3 \text{ V}, I_{VREG3} = 100 \text{ mA}$		1.5	4	Ω
$V_{VFB}  VFB \text{ regulation voltage}  \begin{bmatrix} FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode} & 1.98 & 2.01 & 2.04 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode, } T_{A} = 25^{\circ}\text{C} & 1.9849 & 2.01 & 2.0351 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1.98 & 2.01 & 2.0351 \\ \hline FB \text{ voltage, } $	INTERNA	L REFERENCE VOLTAGE					
$V_{VFB}  VFB \text{ regulation voltage}  \begin{bmatrix} FB \text{ voltage, } I_{VREF} = 0 \text{ A, skip mode, } T_A = 25^{\circ}\text{C} & 1.9849 & 2.01 & 2.0351 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} & 1 & 2.00 & 2.035 & 2.07 \\ FB \text{ voltage, } I_{VREF} = 0 \text{ A, continuous conduction mode} & 2.00 & 2.00 & 2.00 \\ I_{VFB}  VFB \text{ input current} & VFBx = 2.0 \text{ V, } T_A = 25^{\circ}\text{C} & -20 & 20 \\ \hline \textbf{OUTPUT VOLTAGE, } V_{OUT} \text{ DISCHARGE} \\ \end{bmatrix}$	V <sub>IREF</sub>	Internal reference voltage	I <sub>VREF</sub> = 0 A, beginning of ON state	1.95	1.98	2.01	-
$V_{VFB}  VFB \text{ regulation voltage}  FB \text{ voltage, } I_{VREF} = 0 \text{ A, OOA mode} \stackrel{(1)}{=} 2.00  2.035  2.07$ $FB \text{ voltage, } I_{VREF} = 0 \text{ A, continuous conduction } 2.00$ $I_{VFB}  VFB \text{ input current}  VFBx = 2.0 \text{ V, } T_A = 25^{\circ}\text{C} \qquad -20 \qquad 20$ $OUTPUT \text{ VOLTAGE, } V_{OUT} \text{ DISCHARGE}$			FB voltage, I <sub>VREF</sub> = 0 A, skip mode	1.98	2.01	2.04	
FB voltage, I <sub>VREF</sub> = 0 A, continuous conduction mode <sup>(1)</sup> I <sub>VFB</sub> VFB input current VFBx = 2.0 V, T <sub>A</sub> = 25°C -20 20  OUTPUT VOLTAGE, V <sub>OUT</sub> DISCHARGE			FB voltage, $I_{VREF} = 0$ A, skip mode, $T_A = 25$ °C	1.9849	2.01	2.0351	V
mode <sup>(1)</sup>   2.00	$V_{VFB}$	VFB regulation voltage	FB voltage, I <sub>VREF</sub> = 0 A, OOA mode <sup>(1)</sup>	2.00	2.035	2.07	•
OUTPUT VOLTAGE, V <sub>OUT</sub> DISCHARGE			FB voltage, $I_{VREF} = 0$ A, continuous conduction $mode^{(1)}$		2.00		
	I <sub>VFB</sub>	VFB input current	VFBx = 2.0 V, T <sub>A</sub> = 25°C	-20		20	nA
I <sub>Dischg</sub> VOUT discharge current ENC = 0 V, VOx = 0.5 V 10 60	OUTPUT	VOLTAGE, V <sub>OUT</sub> DISCHARGE	<u> </u>				
	I <sub>Dischg</sub>	VOUT discharge current	ENC = 0 V, VOx = 0.5 V	10	60		mA

<sup>(1)</sup> Ensured by design. Not production tested.



over operating free-air temperature range, VIN = 12 V (unless otherwise noted)

	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
OUTPUT	DRIVERS					
Б	DDV/III assistance	Source, V <sub>BSTx - DRVHx</sub> = 100 mV		4	8	
$R_{DRVH}$	DRVH resistance	Sink, V <sub>DRVHx - LLx</sub> = 100 mV		1.5	4	
_	DD\# : .	Source, V <sub>VREG5 - DRVLx</sub> = 100 mV		4	8	Ω
$R_{DRVL}$	DRVL resistance	Sink, V <sub>DRVLx</sub> = 100 mV		1.5	4	
	Dead Con	DRVHx-off to DRVLx-on		10		
t <sub>DEAD</sub>	Dead time	DRVLx-off to DRVHx-on		30		ns
INTERNA	AL BST DIODE					
V <sub>FBST</sub>	Forward voltage	V <sub>VREG5-VBSTx</sub> , I <sub>F</sub> = 10 mA, T <sub>A</sub> = 25 °C	0.7	0.8	0.9	V
I <sub>VBSTLK</sub>	VBST leakage current	VBSTx = 34 V, LLx = 28 V, T <sub>A</sub> = 25 °C		0.1	1	μA
	ND FREQUENCY CONTROL		-		-	
t <sub>ON11</sub>	CH1 on-time 1	V <sub>IN</sub> = 12 V, VO1 = 5 V, 200 kHz setting		2080		
t <sub>ON12</sub>	CH1 on-time 2	V <sub>IN</sub> = 12 V, VO1 = 5 V, 245 kHz setting		1700		
t <sub>ON13</sub>	CH1 on-time 3	V <sub>IN</sub> = 12 V, VO1 = 5 V, 300 kHz setting		1390		
t <sub>ON14</sub>	CH1 on-time 4	V <sub>IN</sub> = 12 V, VO1 = 5 V, 365 kHz setting		1140		
t <sub>ON21</sub>	CH2 on-time 1	V <sub>IN</sub> = 12 V, VO2 = 3.3 V, 250 kHz setting		1100		
t <sub>ON22</sub>	CH2 on-time 2	V <sub>IN</sub> = 12 V, VO2 = 3.3 V, 305 kHz setting		900 730 600 80 300		ns
t <sub>ON23</sub>	CH2 on-time 3	V <sub>IN</sub> = 12 V, VO2 = 3.3 V, 375 kHz setting				
t <sub>ON24</sub>	CH2 on-time 4	V <sub>IN</sub> = 12 V, VO2 = 3.3 V, 460 kHz setting				
t <sub>ON(min)</sub>	Minimum on-time	T <sub>A</sub> = 25 °C				
t <sub>OFF(min)</sub>	Minimum off -ime	T <sub>A</sub> = 25 °C				
SOFTST	ART					
t <sub>SS</sub>	Internal SS time	Internal soft start	1.1	1.6	2.1	ms
POWERO	GOOD				<u> </u>	
		PG in from lower	92.50%	95%	97.50%	
$V_{THPG}$	PG threshold	PG in from higher	102.50%	105%	107.50%	
0		PG hysteresis	2.50%	5%	7.50%	
I <sub>PGMAX</sub>	PG sink current	PGOOD = 0.5 V	5	12		mA
t <sub>PGDEL</sub>	PG delay time	Delay for PG in	350	510	670	μs
	HRESHOLD AND SETTING C	ONDITIONS			<u> </u>	·
		Shutdown			0.4	
V <sub>EN0</sub>	EN0 setting voltage	Enable	2.4			V
I <sub>EN0</sub>	EN0 current	V <sub>EN0</sub> = 0.2 V	2	3.5	5	μA
		Shutdown			0.6	
$V_{ENC}$	ENC threshold voltage	Enable	2			V
		200 kHz/250 kHz			1.5	
		245 kHz/305 kHz	1.9		2.1	
$V_{TONSEL}$	TONSEL setting voltage	300 kHz/375 kHz	2.7		3.6	V
		365 kHz/460 kHz	4.7		0.0	
		Auto skip			1.5	
Vokinos	SKIPSEL setting voltage	PWM only	1.9		2.1	V
$V_{SKIPSEL}$	J. M. OLL Solling Vollage	OOA auto skip	2.7		۷.۱	v



over operating free-air temperature range, VIN = 12 V (unless otherwise noted)

PARAMETER		CONDITIONS	MIN	TYP	MAX	UNIT
PROTECT	TION: CURRENT SENSE				'	
I <sub>TRIP</sub>	TRIPx source current	V <sub>TRIPx</sub> = 920 mV, T <sub>A</sub> = 25°C	9.4	10	10.6	μΑ
TC <sub>ITRIP</sub>	TRIPx current temperature coefficient	On the basis of 25°C		4500		ppm/°C
V <sub>OCLoff</sub>	OCP comparator offset	$((V_{TRIPx-GND}/9)-24 \text{ mV} - V_{GND-LLx}) \text{ voltage, } V_{TRIPx-GND} = 920 \text{ mV}$	-8	0	8	
V <sub>OCL(max)</sub>	Maximum OCL setting	V <sub>TRIPx</sub> = 5 V	185	205	225	mV
V <sub>ZC</sub>	Zero cross detection comparator offset	V <sub>GND-LLx</sub> voltage	-5	0	5	
V <sub>TRIP</sub>	Current limit threshold	V <sub>TRIPx-GND</sub> voltage <sup>(2)</sup> 0.515		2	V	
PROTECT	TON: UNDERVOLTAGE AND O	OVERVOLTAGE PROTECTION				
V <sub>OVP</sub>	OVP trip threshold	OVP detect	110%	115%	120%	
t <sub>OVPDEL</sub>	OVP prop delay			2		μs
V	0	UVP detect	55%	60%	65%	
$V_{UVP}$	Output UVP trip threshold	Hysteresis		10%		
t <sub>UVPDEL</sub>	Output UVP prop delay		20	32	40	μs
t <sub>UVPEN</sub>	Output UVP enable delay	utput UVP enable delay 1.4	1.4	2	2.6	ms
UNDERVO	OLTAGE LOCKOUT (UVLO)					
V	VDECE UVI O throubold	Wake up	4.1	4.2	4.3	
VUVVREG5	VREG5 UVLO threshold	Hysteresis	0.38	0.43	0.48	V
V <sub>UVVREG3</sub>	VREG3 UVLO threshold	Shutdown (2)		VO2-1		
THERMAL	SHUTDOWN					
_	Thermal shutdown threshold	Shutdown temperature (2)		150		°C
T <sub>SDN</sub>	rnermai shuluown threshold	Hysteresis <sup>(2)</sup>			, "C	

<sup>(2)</sup> Ensured by design. Not production tested.

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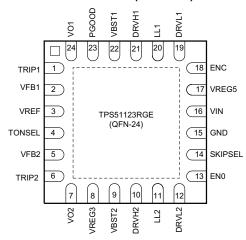
# **DEVICE INFORMATION**

# **Table 1. TERMINAL FUNCTIONS TABLE**

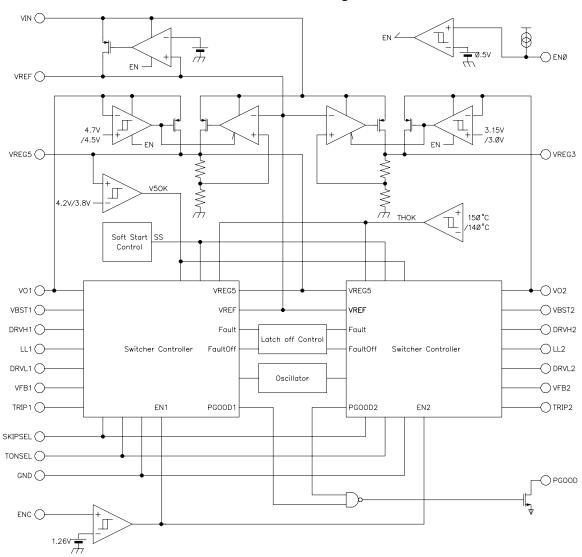
TERMINAL		1/0	DESCRIPTION	
NAME	NO.	1/0	DESCRIPTION	
DRVH1	21	0	High-side N-channel MOSFET driver outputs. LL referenced drivers.	
DRVH2	10	U	nigri-side N-Criainiei MOSFET dilver odiputs. Et referenced dilvers.	
DRVL1	19	0	Low-side N-channel MOSFET driver outputs. GND referenced drivers.	
DRVL2	12	U	Low-side N-Crianner MOSI ET driver outputs. GND referenced drivers.	
EN0	13	I/O	Master enable input. Open: LDOs on, and ready to turn both switcher channels. GND: disable all circuit	
ENC	18	I	Channel 1 and Channel 2 enable input. Pull up to the voltage ranging 3.3-V to 5-V to turn on both switcher channels. Short to ground to shutdown them.	
GND	15	-	Ground.	
LL1	20	- I	Switch node connections for high-side drivers, current limit and control circuitry.	
LL2	11	ı	Switch flode conflections for high-side drivers, current limit and control circuity.	
PGOOD	23	0	Powergood window comparator output for channel 1 and 2. (Logical AND)	
SKIPSEL	14	I	Selection pin for operation mode: OOA auto skip : Connect to VREG3 or VREG5 PWM only: Connect to VREF Auto skip: Connect to GND	
TRIP1	1	I/O	OCL trip setting pins. Connect resistor from this pin to GND to set threshold for synchronous R <sub>DS(on)</sub>	
TRIP2	6		sense.	
TONSEL	4	I	On-time adjustment pin. 365 kHz/460 kHz setting: connect to VREG5 300 kHz/375 kHz setting: connect to VREG3 245 kHz/305 kHz setting: connect to VREF 200 kHz/250 kHz setting: connect to GND	
VBST1	22		Completion of facility aids N. abancal MOCEET driver (based towning)	
VBST2	9		Supply input for high-side N-channel MOSFET driver (boost terminal).	
VFB1	2		CMDC feedback inputs. Connect with feedback register divides	
VFB2	5	ľ	SMPS feedback inputs. Connect with feedback resistor divider.	
VIN	16	I	High voltage power supply input for 5-V/3.3-V LDO.	
VO1	24	I/O	Output connection to SMPS. These terminals work as fixed voltage inputs and output discharge	
VO2	7	1/0	inputs. VO1 and VO2 also work as 5-V and 3.3-V switch over return power input respectively.	
VREF	3	0	2-V reference voltage output. Connect 220-nF to 1-μF ceramic capacitor to Signal GND near the device.	
VREG3	8	0	3.3-V power supply output. Connect a 10- $\mu$ F ceramic capacitor to Power GND near the device. A 1- $\mu$ F ceramic capacitor is acceptable when not loaded.	
VREG5	17	0	5-V power supply output. Connect a 33-μF ceramic capacitor to Power GND near the device.	



#### **QFN PACKAGE (TOP VIEW)**

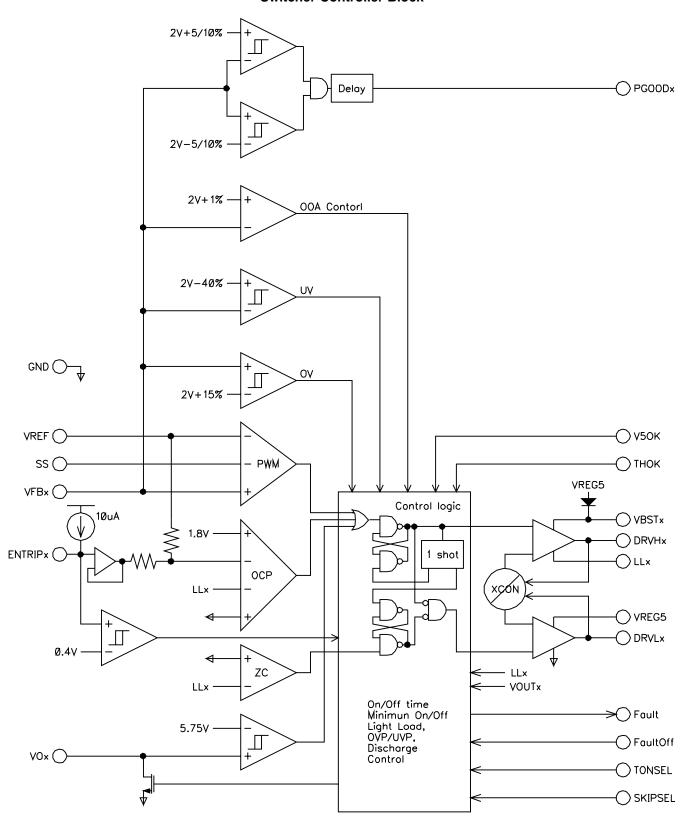


# **Functional Block Diagram**



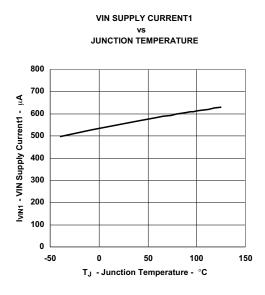


#### **Switcher Controller Block**





# **TYPICAL CHARACTERISTICS**



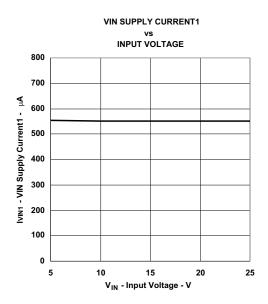


Figure 1.

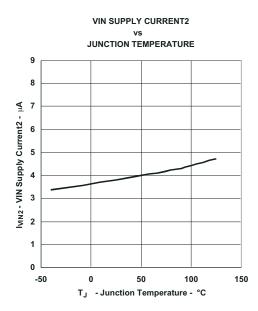


Figure 2.

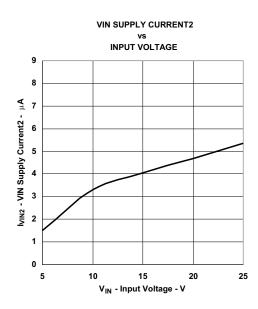
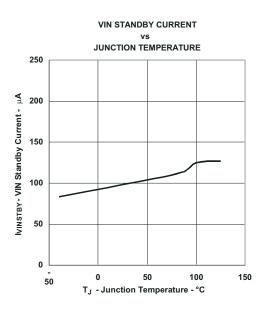


Figure 3.

Figure 4.





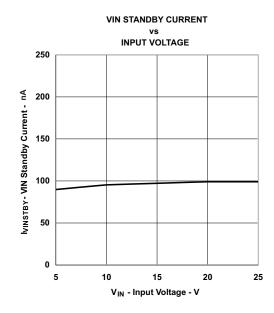


Figure 5.

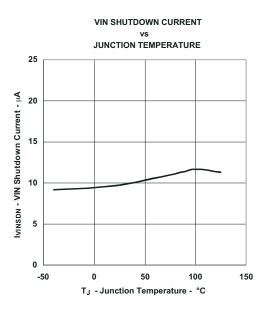


Figure 6.

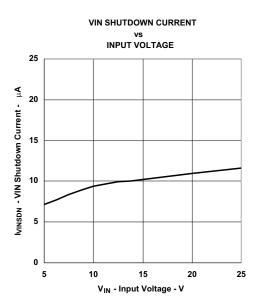
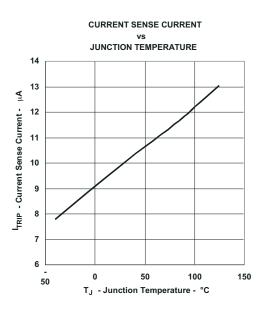


Figure 7. Figure 8.





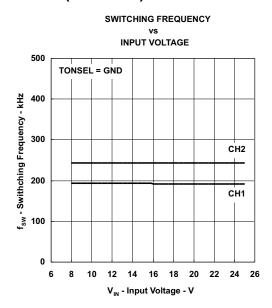


Figure 9.

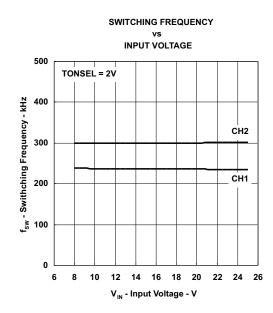


Figure 10.

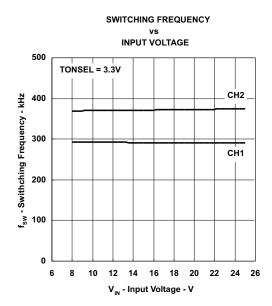
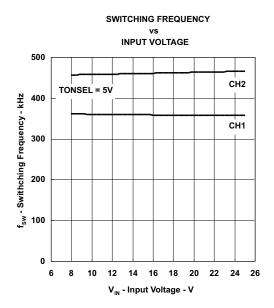


Figure 11.

Figure 12.





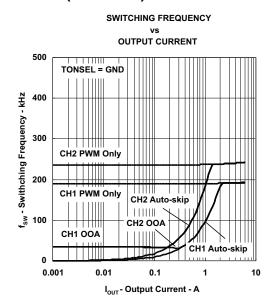


Figure 13.

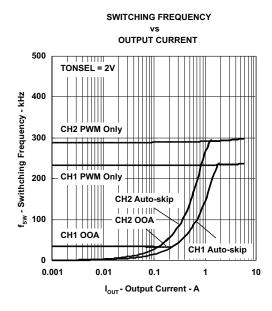


Figure 14.

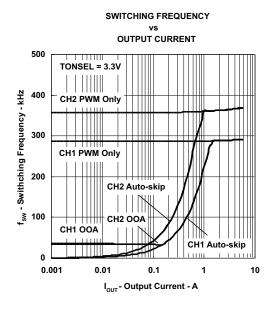
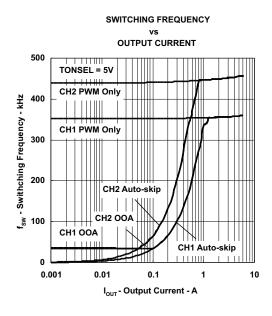


Figure 15.

Figure 16.





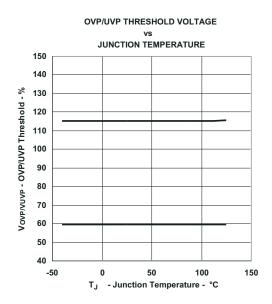


Figure 17.

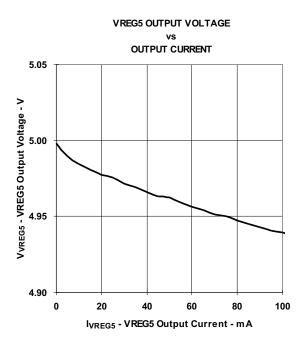


Figure 18.

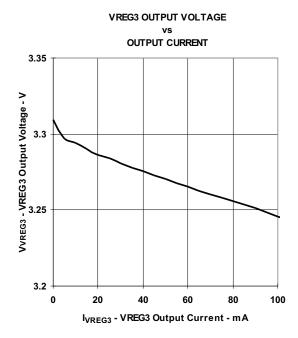
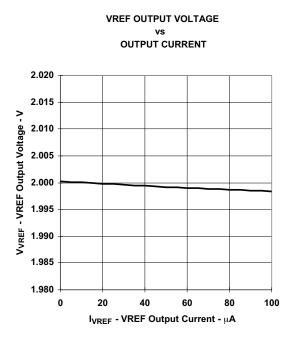


Figure 19.

Figure 20.





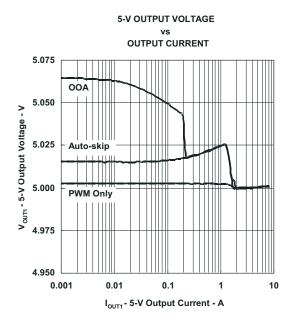


Figure 21.

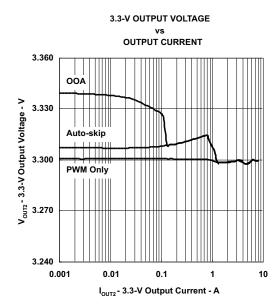


Figure 22.

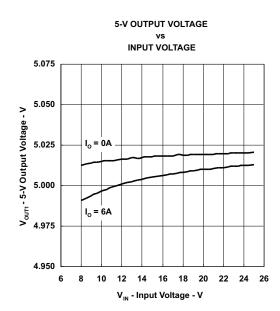
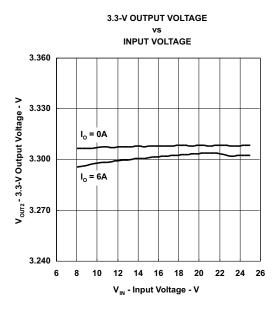


Figure 23.

Figure 24.



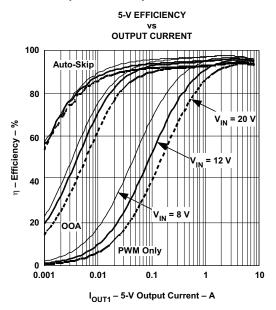


Figure 25. Figure 26.

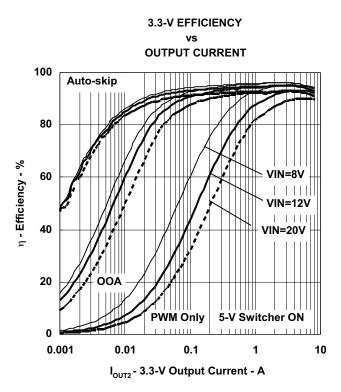
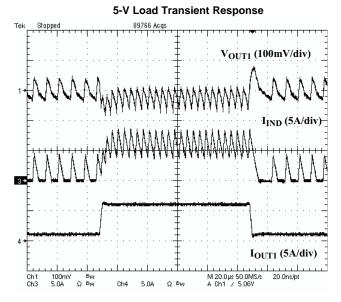


Figure 27.

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#### 3.3-V Load Transient Response

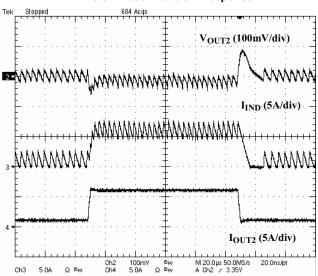
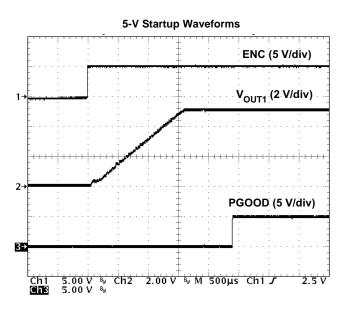


Figure 28.





#### 3.3-V Startup Waveforms

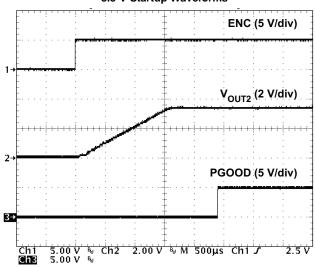


Figure 30.

Figure 31.





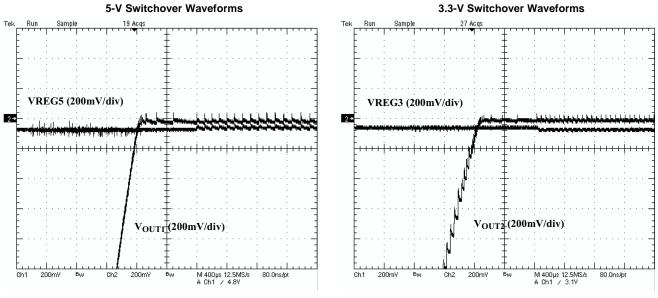


Figure 32. Figure 33.

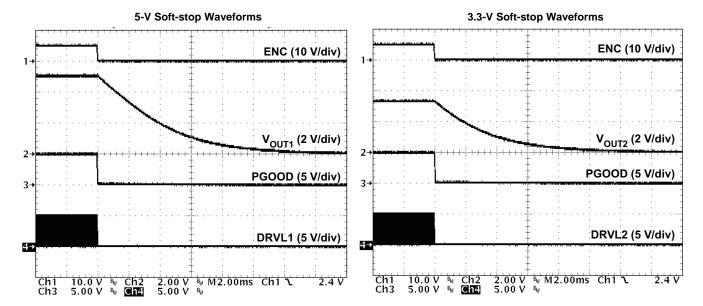


Figure 34. Figure 35.



#### APPLICATION INFORMATION

## **PWM Operations**

The main control loop of the switch mode power supply (SMPS) is designed as an adaptive on-time pulse width modulation (PWM) controller. It supports a proprietary D-CAP™ mode. D-CAP™ mode does not require external compensation circuit and is suitable for low external component count configuration when used with appropriate amount of ESR at the output capacitor(s).

At the beginning of each cycle, the synchronous top MOSFET is turned on, or becomes 'ON' state. This MOSFET is turned off, or becomes 'OFF' state, after internal one shot timer expires. This one shot is determined by  $V_{\text{IN}}$  and  $V_{\text{OUT}}$  to keep frequency fairly constant over input voltage range, hence it is called adaptive on-time control. The MOSFET is turned on again when the feedback point voltage, VFB, decreased to match with internal 2-V reference. The inductor current information is also monitored and should be below the over current threshold to initiate this new cycle. Repeating operation in this manner, the controller regulates the output voltage. The synchronous bottom or the "rectifying" MOSFET is turned on at the beginning of each 'OFF' state to keep the conduction loss minimum. The rectifying MOSFET is turned off before the top MOSFET turns on at next switching cycle or when inductor current information detects zero level. In the auto-skip mode or the OOA skip mode, this enables seamless transition to the reduced frequency operation at light load condition so that high efficiency is kept over broad range of load current.

## **Adaptive On-Time Control and PWM Frequency**

TPS51123 does not have a dedicated oscillator on board. However, the part runs with pseudo-constant frequency by feed-forwarding the input and output voltage into the on-time, one-shot timer. The on-time is controlled inverse proportional to the input voltage and proportional to the output voltage so that the duty ratio will be kept as VOUT/VIN technically with the same cycle time. The frequencies are set by TONSEL terminal connection as Table 2.

**Table 2. TONSEL Connection and Switching Frequency** 

TONSEL CONNECTION	SWITCHING FREQUENCY (kHz)			
TONSEL CONNECTION	CH1	CH2		
GND	200	250		
VREF	245	305		
VREG3	300	375		
VREG5	365	460		



#### **Loop Compensation**

From small-signal loop analysis, a buck converter using D-CAP<sup>TM</sup> mode can be simplified as below.

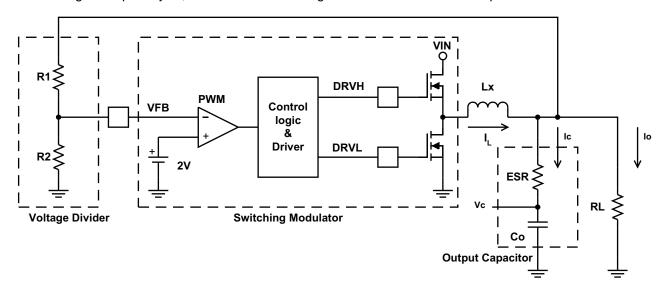


Figure 36. Simplifying the Modulator

The output voltage is compared with internal reference voltage after divider resistors, R1 and R2. The PWM comparator determines the timing to turn on high-side MOSFET. The gain and speed of the comparator is high enough to keep the voltage at the beginning of each on cycle substantially constant. For the loop stability, the 0dB frequency,  $f_0$ , defined below need to be lower than 1/4 of the switching frequency.

$$f_0 = \frac{1}{2\pi \times \mathsf{ESR} \times \mathsf{C}_{\mathsf{O}}} \le \frac{f_{\mathsf{SW}}}{4} \tag{1}$$

As  $f_0$  is determined solely by the output capacitor's characteristics, loop stability of D-CAP<sup>TM</sup> mode is determined by the capacitor's chemistry. For example, specialty polymer capacitors (SP-CAP) have Co in the order of several 100  $\mu$ F and ESR in range of 10 m $\Omega$ . These make  $f_0$  on the order of 100 kHz or less and the loop will be stable. However, ceramic capacitors have  $f_0$  at more than 700 kHz, which is not suitable for this operational mode.

## Ramp Signal

The TPS51123 adds a ramp signal to the 2-V reference in order to improve its jitter performance. As described in the previous section, the feedback voltage is compared with the reference information to keep the output voltage in regulation. By adding a small ramp signal to the reference, the S/N ratio at the onset of a new switching cycle is improved. Therefore the operation becomes less jitter and stable. The ramp signal is controlled to start with 20mV at the beginning of ON-cycle and to become 0 mV at the end of OFF-cycle in steady state. By using this scheme, the TPS51123 improve jitter performance without sacrificing the reference accuracy.



#### **Light Load Condition in Auto-Skip Operation**

The TPS51123 automatically reduces switching frequency at light load conditions to maintain high efficiency. This reduction of frequency is achieved smoothly and without increase of  $V_{\text{OUT}}$  ripple. Detail operation is described as follows. As the output current decreases from heavy load condition, the inductor current is also reduced and eventually comes to the point that its 'valley' touches zero current, which is the boundary between continuous conduction and discontinuous conduction modes. The rectifying MOSFET is turned off when this zero inductor current is detected. As the load current further decreased, the converter runs in discontinuous conduction mode and it takes longer and longer to discharge the output capacitor to the level that requires next 'ON' cycle. The ON time is kept the same as that in the heavy load condition. In reverse, when the output current increase from light load to heavy load, switching frequency increases to the preset value as the inductor current reaches to the continuous conduction. The transition load point to the light load operation  $I_{\text{OUT(LL)}}$  (i.e. the threshold between continuous and discontinuous conduction mode) can be calculated as follows;

$$I_{OUT(LL)} = \frac{1}{2 \times L \times f} \times \frac{\left(V_{IN} - V_{OUT}\right) \times V_{OUT}}{V_{IN}}$$
(2)

where f is the PWM switching frequency.

Switching frequency versus output current in the light load condition is a function of L,  $V_{IN}$  and  $V_{OUT}$ , but it decreases almost proportional to the output current from the  $I_{OUT(LL)}$  shown in Equation 2. For example, it ise 60 kHz at  $I_{OUT(LL)}$ /5 if the frequency setting is 300 kHz.

# Out-of-Audio™ Light-Load Operation

Out-of-Audio<sup>TM</sup> (OOA) light-load mode is a unique control feature that keeps the switching frequency above acoustic audible frequencies toward virtually no load condition while maintaining best of the art high conversion efficiency. When the Out-of-Audio<sup>TM</sup> operation is selected, OOA control circuit monitors the states of both MOSFET and force to change into the 'ON' state if both of MOSFETs are off for more than 32  $\mu$ s. This means that the top MOSFET is turned on even if the output voltage is higher than the target value so that the output capacitor is tends to be overcharged.

The OOA control circuit detects the over-voltage condition and begins to modulate the on time to keep the output voltage regulated. As a result, the output voltage becomes 0.5% higher than normal light-load operation.

#### **Enable and Soft Start**

EN0 is the control pin of VREG5, VREG3 and VREF regulators. Bring this node down to GND disables those three regulators and minimize the shutdown supply current to 10  $\mu$ A. Pulling this node up to 3.3 V or 5 V will turn the three regulators on to standby mode. The two switch mode power supplies (channel-1, channel-2) become ready to enable at this standby mode. The TPS51123 has an internal, 1.6 ms, voltage servo softstart for each channel. When the ENC pin becomes higher than the enable threshold voltage, which is typically 1.26 V, an internal DAC begins ramping up the reference voltage to both of the PWM comparators at the same time. Smooth control of the output voltage is maintained during start up.

**Table 3. Enabling State** 

EN0	ENC	VREF	VREG5	VREG3	CH1	CH2
GND	Don't Care	Off	Off	Off	Off	Off
Open	Off	On	On	On	Off	Off
Open	On	On	On	On	On	On

#### **VREG5/VREG3 Linear Regulators**

There are two sets of 100-mA standby linear regulators which outputs 5 V and 3.3 V, respectively. The VREG5 serves as the main power supply for the analog circuitry of the device and provides the current for gate drivers. The VREG3 is intended mainly for auxiliary 3.3-V supply for the notebook system during standby mode.

Add a ceramic capacitor with a value of at least 33  $\mu F$  and place it close to the VREG5 pin, and add at most 10  $\mu F$  to the VREG3 pin. Total capacitance connected to the VREG3 pin should not exceed 10  $\mu F$ .



#### VREG5 Switch Over

When the VO1 voltage becomes higher than 4.7 V AND channel-1 internal powergood flag is generated, internal 5-V LDO regulator is shut off and the VREG5 output is connected to VO1 by internal switch over MOSFET. The 510-µs powergood delay helps a switch over without glitch.

#### **VREG3 Switch Over**

When the VO2 voltage becomes higher than 3.15 V AND channel-2 internal powergood flag is generated, internal 3.3-V LDO regulator is shut off and the VREG3 output is connected to VO2 by internal switch over MOSFET. The 510-µs powergood delay helps a switch over without glitch.

#### **Powergood**

The TPS51123 has one powergood output that indicates 'high' when both switcher outputs are within the targets (AND gated). The powergood function is activated with 2-ms internal delay after ENC goes high. If the output voltage becomes within ±5% of the target value, internal comparators detect power good state and the powergood signal becomes high after 510-µs internal delay. Therefore PGOOD goes high around 2.5 ms after ENC goes high. If the output voltage goes outside of ±10% of the target value, the powergood signal becomes low after 2-µs internal delay. The powergood output is an open drain output and is needed to be pulled up outside.

Also note that, in the case of Auto-skip or Out-of-Audio<sup>™</sup> mode, if the output voltage goes +10% above the target value and the power-good signal flags low, then the loop attempts to correct the output by turning on the low-side driver (forced PWM mode). After the feedback voltage returns to be within +5% of the target value and the power-good signal goes high, the controller returns back to auto-skip mode or Out-of-Audio<sup>™</sup> mode.

#### **Output Discharge Control**

When ENC is low, the TPS51123 discharges outputs using internal MOSFET which is connected to VOx and GND. The current capability of these MOSFETs is limited to discharge slowly.

#### Low-Side Driver

The low-side driver is designed to drive high current low  $R_{DS(on)}$  N-channel MOSFET(s). The drive capability is represented by its internal resistance, which are 4  $\Omega$  for VREG5 to DRVLx and 1.5  $\Omega$  for DRVLx to GND. A dead time to prevent shoot through is internally generated between top MOSFET off to bottom MOSFET on, and bottom MOSFET off to top MOSFET on. 5-V bias voltage is delivered from VREG5 supply. The instantaneous drive current is supplied by an input capacitor connected between VREG5 and GND. The average drive current is equal to the gate charge at Vgs = 5 V times switching frequency. This gate drive current as well as the high-side gate drive current times 5 V makes the driving power which need to be dissipated from TPS51123 package.

#### **High-Side Driver**

The high-side driver is designed to drive high current, low  $R_{DS(on)}$  N-channel MOSFET(s). When configured as a floating driver, 5-V bias voltage is delivered from VREG5 supply. The average drive current is also calculated by the gate charge at Vgs = 5 V times switching frequency. The instantaneous drive current is supplied by the flying capacitor between VBSTx and LLx pins. The drive capability is represented by its internal resistance, which are 4  $\Omega$  for VBSTx to DRVHx and 1.5 $\Omega$  for DRVHx to LLx.

Product Folder Links: *TPS51123* 

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#### **Current Protection**

TPS51123 has cycle-by-cycle over current limiting control. The inductor current is monitored during the 'OFF' state and the controller keeps the 'OFF' state during the inductor current is larger than the over current trip level. In order to provide both good accuracy and cost effective solution, TPS51123 supports temperature compensated MOSFET  $R_{DS(on)}$  sensing. The TRIPx pin should be connected to GND through the trip voltage setting resistor,  $R_{TRIP}$ . TRIPx terminal sources  $I_{TRIP}$  current, which is 10  $\mu$ A typically at room temperature, and the trip level is set to the OCL trip voltage  $V_{TRIP}$  as below. Note that the  $V_{TRIP}$  is limited up to about 205 mV internally.

$$V_{TRIP} (mV) = \frac{R_{TRIP} (k\Omega) \times I_{TRIP} (\mu A)}{9} - 24 (mV)$$
(3)

Note that when TRIPx voltage is under a certain thershould (typically 0.4V), the switcher channel concerned is shut down. The inductor current is monitored by the voltage between GND pin and LLx pin so that LLx pin should be connected to the drain terminal of the bottom MOSFET properly. Itrip has 4500 ppm/ $^{\circ}$ C temperature slope to compensate the temperature dependency of the R<sub>DS(on)</sub>. GND is used as the positive current sensing node so that GND should be connected to the proper current sensing device, i.e. the source terminal of the bottom MOSFET.

As the comparison is done during the 'OFF' state, V<sub>TRIP</sub> sets valley level of the inductor current. Thus, the load current at over current threshold, I<sub>OCP</sub>, can be calculated as follows;

$$I_{OCP} = \frac{V_{TRIP}}{R_{DS(on)}} + \frac{I_{RIPPLE}}{2} = \frac{V_{TRIP}}{R_{DS(on)}} + \frac{1}{2 \times L \times f} \times \frac{\left(V_{IN} - V_{OUT}\right) \times V_{OUT}}{V_{IN}}$$
(4)

In an over current condition, the current to the load exceeds the current to the output capacitor thus the output voltage tends to fall down. Eventually, it ends up with crossing the under voltage protection threshold and shutdown both channels.

#### Overvoltage and Undervoltage Protection

TPS51123 monitors a resistor divided feedback voltage to detect over and under voltage. When the feedback voltage becomes higher than 115% of the target voltage, the OVP comparator output goes high and the circuit latches as the top MOSFET driver OFF and the bottom MOSFET driver ON.

Also, TPS51123 monitors VOx voltage directly and if it becomes greater than 5.75 V the TPS51123 turns off the top MOSFET driver.

When the feedback voltage becomes lower than 60% of the target voltage, the UVP comparator output goes high and an internal UVP delay counter begins counting. After 32 µs, TPS51123 latches OFF both top and bottom MOSFETs drivers, and shut off both drivers of another channel. This function is enabled after 2 ms following ENC has become high.



#### **UVLO Protection**

TPS51123 has VREG5 under voltage lock out protection (UVLO). When the VREG5 voltage is lower than UVLO threshold voltage both switch mode power supplies are shut off. This is non-latch protection. When the VREG3 voltage is lower than (VO2 - 1 V), both switch mode power supplies are also shut off

#### **Thermal Shutdown**

TPS51123 monitors the temperature of itself. If the temperature exceeds the threshold value (typically 150°C), TPS51123 is shut off including LDOs. This is non-latch protection.

#### **External Parts Selection**

The external components selection is much simple in D-CAP™ Mode.

#### 1. Determine output voltage

The output voltage is programmed by the voltage-divider resistor, R1 and R2, as shown in Figure 36. R1 is connected between VFBx pin and the output, and R2 is connected between the VFBx pin and GND.

Recommended R2 value is from 10 k $\Omega$  to 20 k $\Omega$ . Determine R1 using equation as below.

$$R1 = \frac{\left(V_{\text{OUT}} - 2.0\right)}{2.0} \times R2 \tag{5}$$

#### 2. Choose the Inductor

The inductance value should be determined to give the ripple current of approximately 1/4 to 1/2 of maximum output current. Larger ripple current increases output ripple voltage and improves S/N ratio and helps stable operation.

$$L = \frac{1}{I_{\text{IND(ripple)}} \times f} \times \frac{\left(V_{\text{IN(max)}} - V_{\text{OUT}}\right) \times V_{\text{OUT}}}{V_{\text{IN(max)}}} = \frac{3}{I_{\text{OUT(max)}} \times f} \times \frac{\left(V_{\text{IN(max)}} - V_{\text{OUT}}\right) \times V_{\text{OUT}}}{V_{\text{IN(max)}}}$$
(6)

The inductor also needs to have low DCR to achieve good efficiency, as well as enough room above peak inductor current before saturation. The peak inductor current can be estimated as follows.

$$I_{IND(peak)} = \frac{V_{TRIP}}{R_{DS(on)}} + \frac{1}{L \times f} \times \frac{\left(V_{IN(max)} - V_{OUT}\right) \times V_{OUT}}{V_{IN(max)}}$$
(7)

#### 3. Choose the Output Capacitor(s)

Organic semiconductor capacitor(s) or specialty polymer capacitor(s) are recommended. Determine ESR to meet required ripple voltage. A quick approximation is as shown in Equation 8. This equation is based on that required output ripple slope is approximately 20 mV per T<sub>SW</sub> (switching period) in terms of VFB terminal voltage.

$$ESR = \frac{V_{OUT} \times 20 (mV) \times (1-D)}{2(V) \times I_{RIPPLE}} - \frac{20 (mV) \times L \times f}{2(V)}$$

where

- D is the duty cycle
- the required output ripple slope is approximately 20 mV per t<sub>SW</sub> (switching period) in terms of VFB terminal voltage

#### 4. Choose the Low-Side MOSFET

It is highly recommended that the low-side MOSFET should have an integrated Schottky barrier diode, or an external Schottky barrier diode in parallel to achieve stable operation.



#### **Layout Considerations**

Certain points must be considered before starting a layout work using the TPS51123.

- TPS51123 has only one GND pin and special care of GND trace design makes operation stable, especially when both channels operate. Group GND terminals of output voltage divider of both channels and the VREF capacitor as close as possible, and connect them to an inner GND plane with PowerPad and the overcurrent setting resistor, as shown in the thin GND line of Figure 37. This trace is named Signal Ground (SGND). Group ground terminals of VIN capacitor(s), VOUT capacitor(s) and source of low-side MOSFETs as close as possible, and connect them to another inner GND plane with GND pin of the device and the GND terminal of VREG3 and VREG5 capacitors, as shown in the bold GND line of Figure 37. This trace is named Power Ground (PGND). SGND should be connected to PGND at the middle point between ground terminal of VOUT capacitors.
- Inductor, VOUT capacitor(s), VIN capacitor(s) and MOSFETs are the power components and should be
  placed on one side of the PCB (solder side). Power components of each channel should be at the same
  distance from the TPS51123. Other small signal parts should be placed on another side (component side).
  Inner GND planes should shield and isolate the small signal traces from noisy power lines.
- PCB trace defined as LLx node, which connects to source of high-side MOSFET, drain of low-side MOSFET and high-voltage side of the inductor, should be as short and wide as possible.
- VREG5 requires capacitance of at least 33-μF and VREG3 requires capacitance of at most 10-μF. VREF requires a 220-nF ceramic bypass capacitor which should be placed close to the device and traces should be no longer than 10 mm.
- Connect the overcurrent setting resistors from TRIPx to SGND and close to the device, right next to the
  device if possible.
- The discharge path (VOx) should have a dedicated trace to the output capacitor; separate from the output voltage sensing trace. When LDO5 is switched over Vo1 trace should be 1.5 mm with no loops. When LDO3 is switched over and loaded Vo2 trace should also be 1.5 mm with no loops. There is no restriction for just monitoring Vox. Make the feedback current setting resistor (the resistor between VFBx to SGND) close to the device. Place on the component side and avoid vias between this resistor and the device.
- Connections from the drivers to the respective gate of the high-side or the low-side MOSFET should be as short as possible to reduce stray inductance. Use 0.65-mm (25 mils) or wider trace and via(s) of at least 0.5 mm (20 mils) diameter along this trace.
- All sensitive analog traces and components such as VOx, VFBx, VREF, GND, EN0, TRIPx, PGOOD, TONSEL and SKIPSEL should be placed away from high-voltage switching nodes such as LLx, DRVLx, and DRVHx nodes to avoid coupling.
- Traces for VFB1 and VFB2 should be short and laid apart each other to avoid channel to channel interference.
- In order to effectively remove heat from the package, prepare thermal land and solder to the package's thermal pad. Three by three or more vias with a 0.33-mm (13 mils) diameter connected from the thermal land to the internal ground plane should be used to help dissipation. This thermal land underneath the package should be connected to SGND, and should NOT be connected to PGND.



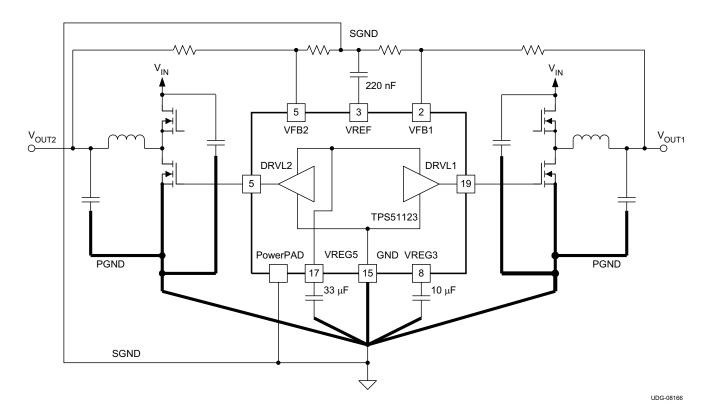


Figure 37. Ground System

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\* Driver and switch node traces are shown for CH1 only.

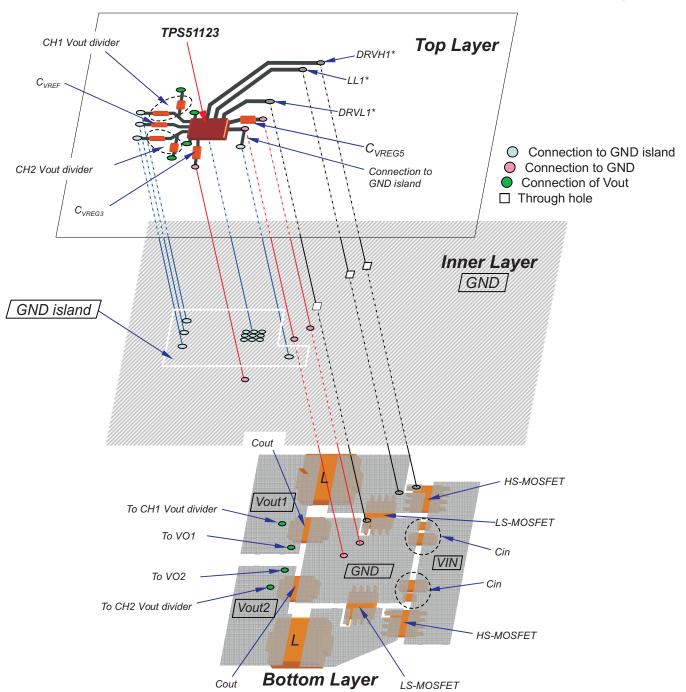


Figure 38. PCB Layout

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# **Application Circuit**

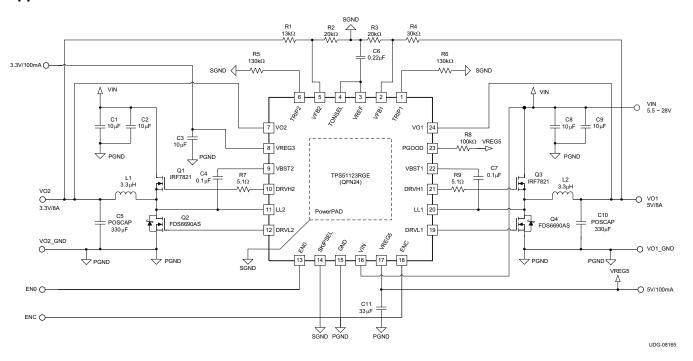


Figure 39. 5-V/8-A, 3.3-V/8-A Application Circuit (245-kHz/305-kHz Setting)

Table 4. List of Materials for 5-V/8-A, 3.3-V/8-A Application Circuit

REFERENCE DESIGNATOR	SPECIFICATION	MANUFACTURER	PART NUMBER
C1, C2, C8, C9	10 μF/25 V	Taiyo Yuden	TMK325BJ106MM
C3	10 μF/6.3 V	TDK	C2012X5R0J106K
C11	33 μF/6.3V	TDK	C3216X5RBJ336M
C5, C10	330 μF/6.3 V/25 mΩ	Sanyo	6TPE330ML
L1, L2	3.3 μH, 15.6 A, 5.92 mΩ	TOKO	FDA1055-3R3M
Q1, Q3	30 V, 9.5 mΩ	IR	IRF7821
Q2, Q4 <sup>(1)</sup>	30 V, 12 mΩ	Fairchild	FDS6690AS

(1) Use a MOSFET with an integrated Schottky barrier diode (SBD) for the low-side, or add an SBD in parallel with a normal MOSFET.



# **REVISION HISTORY**

nanges from Revision C (March 2012) to Revision D  Added ESD ratings to the ABSOLUTE MAXIMUM RATINGS table	Page
Added LL1, LL2, pulse width < 20 ns parameter with a value of -5.0 V to 30 V.	2
Changes from Revision C (March 2012) to Revision D	Page
Added ESD ratings to the ABSOLUTE MAXIMUM RATINGS table	2
Added clarity to Switcher Controller Block diagram	9
Changes from Revision D (SEPTEMBER 2012) to Revision E	Page
Added specification for VFB regulation voltage in ELECTRICAL CHARACTERISTICS table	4



# PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TPS51123RGER	ACTIVE	VQFN	RGE	24	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	(51123, 51123A)	Samples
TPS51123RGET	ACTIVE	VQFN	RGE	24	250	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	51123	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 12-Aug-2015

# TAPE AND REEL INFORMATION





Α0	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

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Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS51123RGER	VQFN	RGE	24	3000	330.0	12.4	4.25	4.25	1.15	8.0	12.0	Q2
TPS51123RGET	VQFN	RGE	24	250	180.0	12.4	4.25	4.25	1.15	8.0	12.0	Q2

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#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
TPS51123RGER	VQFN	RGE	24	3000	367.0	367.0	35.0	
TPS51123RGET	VQFN	RGE	24	250	210.0	185.0	35.0	

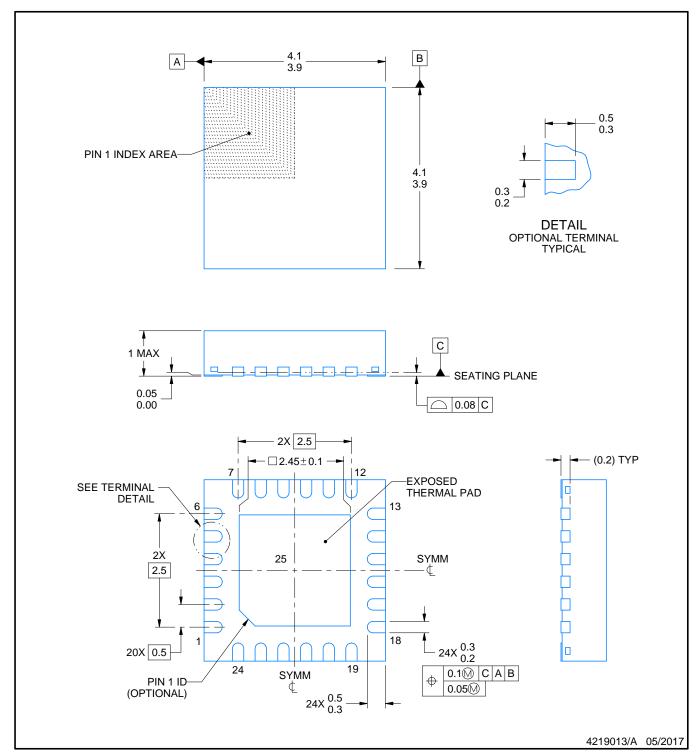


Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4204104/H



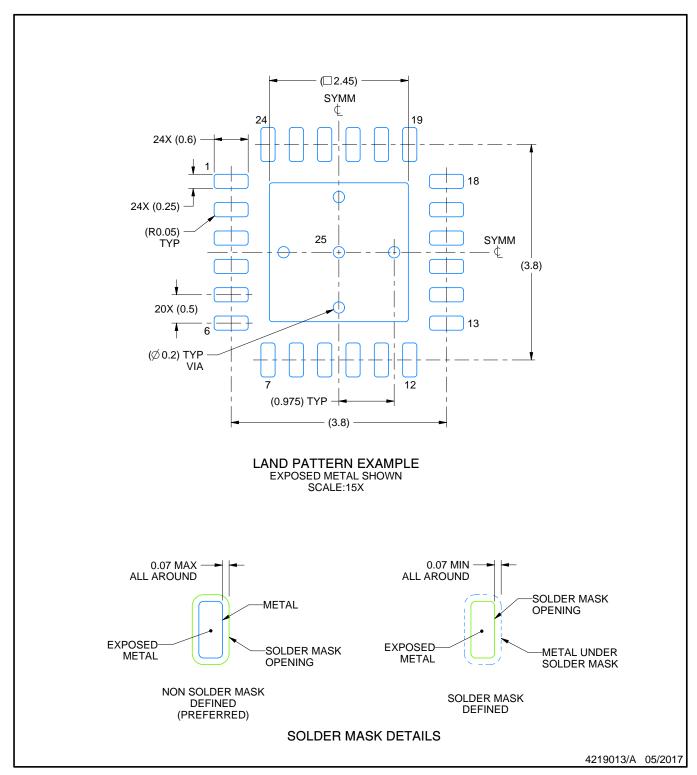




#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

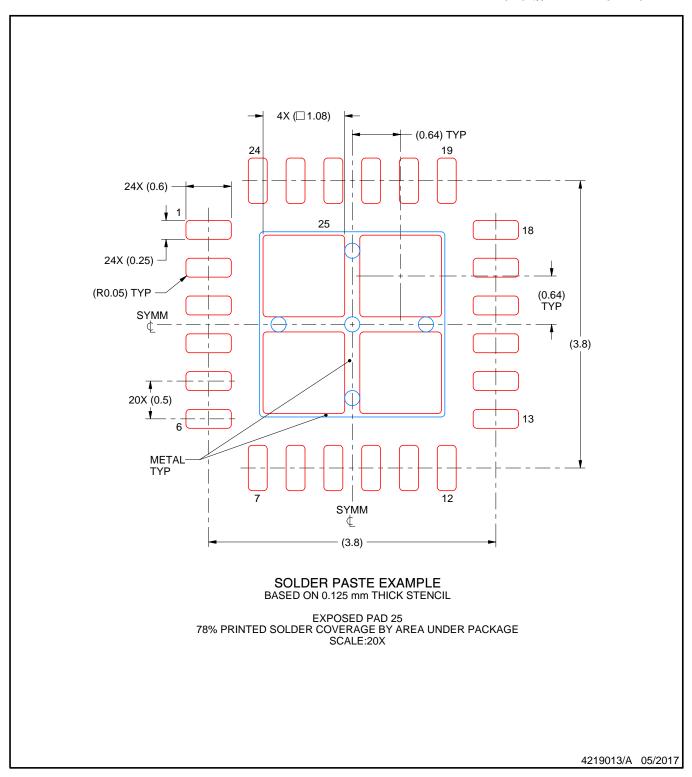




NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.





NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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